RPI-1040

Thin type / Surface Mount type 4 Direction Detector

Absolute maximum ratings (Ta=25°C)

	Parameter	Symbol	Limits	Unit
Input (LED)	Forward current	I_F	50	mA
	Reverse voltage	V_R	5	V
	Power dissipation	P_D	80	mW
Output (photo-transistor)	Collector-emitter voltage	V_{CEO}	30	V
	Emitter-collector voltage	V_{ECO}	4.5	V
	Collector current	I_C	30	mA
	Collector power dissipation	P_C	80	mW
	Operating temperature	Topr	−25 to +85	°C
	Storage temperature	Tstg	−30 to +85	°C

Applications

DSC(Digital steal camera)
DVC(Digital video camera)
Digital handy phone, Fan herater,
Projector

Features

1) Surface Mount type
2) Optical Sensor
3) 4 Pirection Detector
4) Noise less type

Electrical and optical characteristics (Ta=25°C)

	Parameter		Symbol	Min.	Typ.	Max.	Unit	Conditions
Input characteristics	Forward voltage		V_F	–	1.1	1.3	V	I_F=5mA
	Reverse current		I_R	–	–	10	μA	V_R=10V
Output characteristics	Dark current		I_{CEO}	–	–	0.5	μA	V_{CE}=10V
Transfer characteristics	Collector current		I_C	50	80	–	μA	V_{CE}=5V, I_F=5mA
	DC leakage current		I_{leak}	–	10	20	μA	V_{CE}=5V, I_F=5mA
	Collector-emitter saturation voltage		$V_{CE(sat)}$	–	–	0.4	V	I_F=5mA, I_C=0.05mA
	Response time	Rise time	tr	–	10	–	μs	V_{CC}=5V, I_C=0.05mA, R_L=100Ω
		Fall time	tf	–	10	–	μs	
Infrared light emitter diode	Peak light emitting wavelength		λ_P	–	950	–	nm	I_F=50mA * Non-coherent Infrared light emitting diode used.
Photo transistor	Maximum sensitivity wavelength		λ_P	–	800	–	nm	–

Electrical and optical characteristics curves

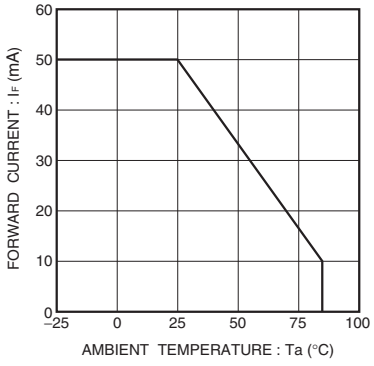


Fig.1 Forward current falloff

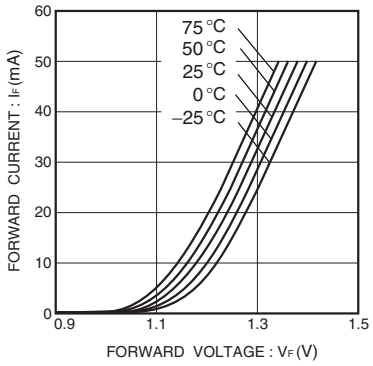


Fig.2 Forward current vs. forward voltage

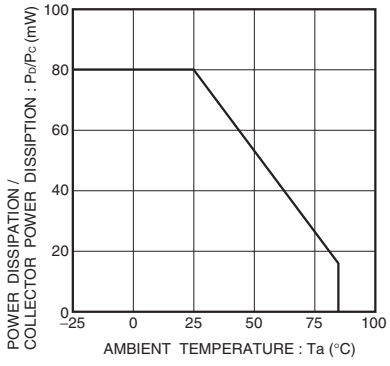


Fig.3 Power dissipation / collector power dissipation vs. ambient temperature

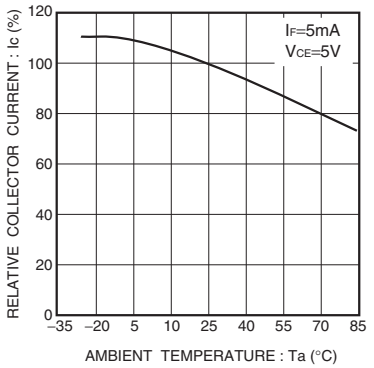


Fig.4 Relative output vs. ambient temperature

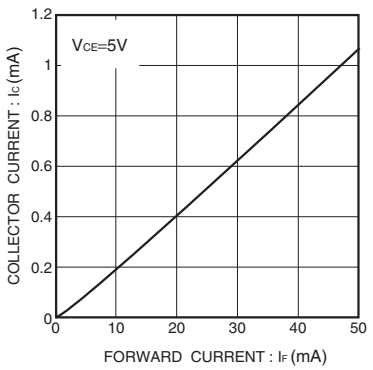


Fig.5 Collector current vs. forward current

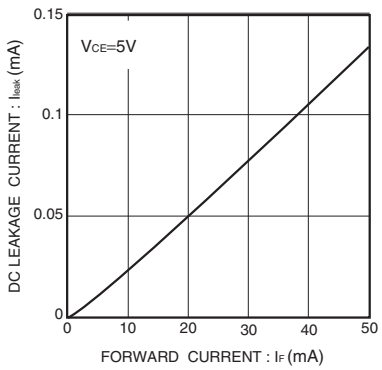
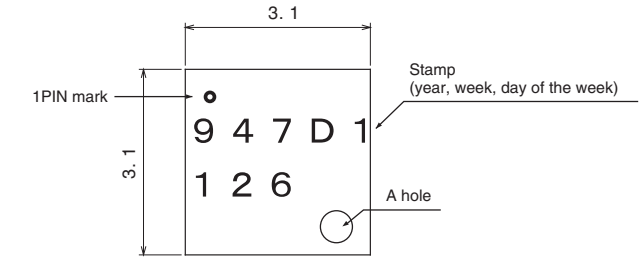
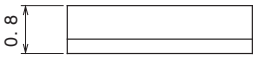
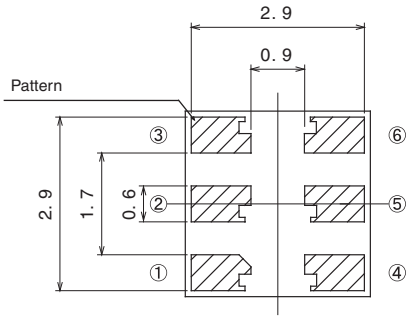


Fig.6 DC leakage current vs.

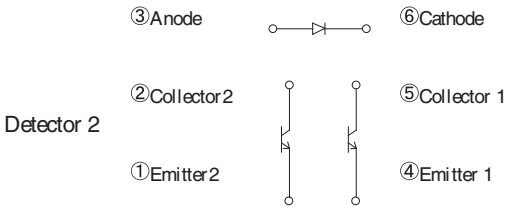
Dimensions (Unit : mm)







Internal connection diagram



Notes:
Unspecified tolerance shall be ±0.2 .

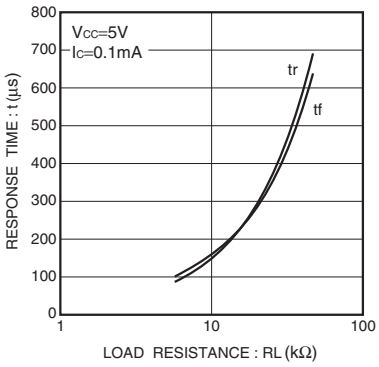


Fig.7 Response time vs. load resistance

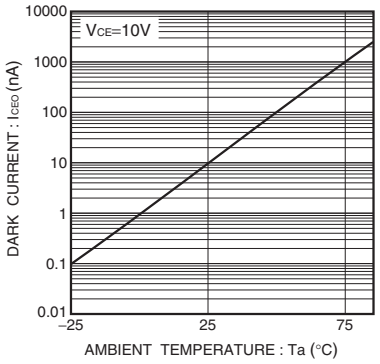


Fig.8 Dark current vs. ambient temperature

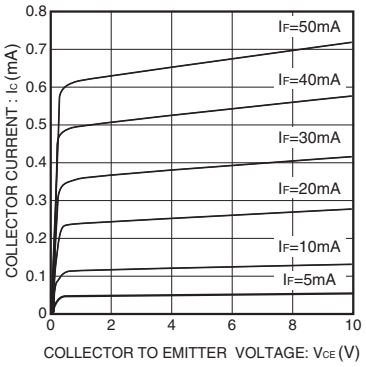


Fig.9 Output characteristics

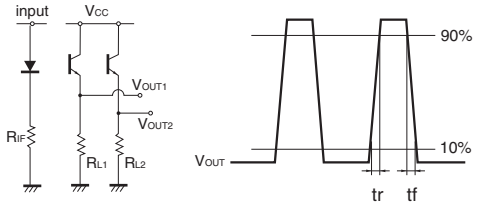


Fig.10 Response time measurement circuit

Notes

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